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Part Number: 0736440016

Status: Active

Overview: HDM Backplane Connector System

Description: HDM Board-to-Board Backplane Header, Vertical, SMC, Press-Fit, Guide Post Location

B, Polarizing Key Position N/A, 72 Circuits, Mating Length 5.00mm

Documents:

3D ModelPackaging Specification PK-70873-0818 (PDF)3D Model (PDF)Test Summary TS-73670-990-001 (PDF)Drawing (PDF)RoHS Certificate of Compliance (PDF)

Agency Certification

CSA LR19980 UL E29179

General

Product Family Backplane Connectors

Series 73644
Application Backplane
Comments Standard Press-Fit

Component Type PCB Header

Overview <u>HDM Backplane Connector System</u>

Product Name HDM

UPC 800754256490

Physical

Circuits (Loaded) 72
Circuits (maximum) 72

Color - Resin Black, Natural

Durability (mating cycles max)

First Mate / Last Break

Flammability

Guide to Mating Part

Keying to Mating Part

None

Material - Metal Phosphor Bronze, Stainless Steel

Material - Plating Mating Gold Material - Plating Termination Gold

Material - Resin High Temperature Thermoplastic

Net Weight 5.610/g Number of Columns 12

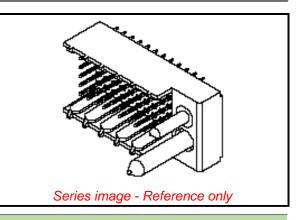
Number of Pairs Open Pin Field

Number of Rows Orientation Vertical PC Tail Length 3.50mm PCB Locator No **PCB** Retention Yes 2.50mm PCB Thickness - Recommended Packaging Type Tube Pitch - Mating Interface 2.00mm Pitch - Termination Interface 2.00mm Plating min - Mating 0.762um Plating min - Termination 0.051um

Polarized to PCB No Stackable Yes Surface Mount Compatible (SMC) Yes

Temperature Range - Operating -55° to +105°C

Termination Interface: Style Through Hole - Compliant Pin



EU ELV Not Relevant

NOT Relevant

EU RoHS China RoHS

Compliant REACH SVHC Not Contained Per -ECHA_01_2020 (16 January 2020 Halogen-Free

Status

Low-Halogen

For more information, please visit Contact US

China ROHS Green Image
ELV Not Relevant
ROHS Phthalates Not Contained

Search Parts in this Series

73644 Series

Mates With

73632 HDM+ Board-to-Board Daughtercard Receptacle. 73780 HDM Board-to-Board

Daughtercard Receptacle

Application Tooling | FAQ

Tooling specifications and manuals are found by selecting the products below. Crimp Height Specifications are then contained in the Application Tooling Specification document.

Global

DescriptionProduct #Extraction Tool621001000Backplane Insertion621001400

Signal Contact Tool

Backplane Signal 622008502

Insertion Module Press-In Tool for 2.00mm Pitch HDM* Board-to-Board Backplane Header **Electrical**

Current - Maximum per Contact1.0AData Rate1.0 GbpsReal Signals (per 25mm)75ShieldedNo

Voltage - Maximum 250V AC

Solder Process Data

Lead-freeProcess Capability N/A

Material Info

Reference - Drawing Numbers

Packaging Specification PK-70873-0818
Sales Drawing SDA-73644-XXXX
Test Summary TS-73670-990-001

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